

Data Sheet

Description

The EG01 is a fast recovery diode of 400 V / 0.7 A. The maximum $t_{\rm rr}$ of 100 ns is realized by optimizing a life-time control.

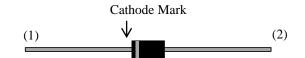
Features

•	V _{RM} 400	V
	I _{F(AV)} 0.7	
	V _F	
	t_{rr1} 100 p	

• Bare Leads: Pb-free (RoHS Compliant)

Package

Axial (φ 2.7 × 5.0L / φ 0.6)





- (1) Cathode
- (2) Anode

Not to scale

Applications

- Secondary Side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck and Buck-boost Converter)

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C

Parameter	Symbol	Rating Uni		Conditions	
Peak Repetitive Reverse Voltage	V _{RSM}	400	V		
Repetitive Reverse Voltage	V _{RM}	400	V		
Average Forward Current	I _{F(AV)}	0.7	A	See Figure 2 and Figure 3	
Surge Forward Current	I_{FSM}	15	A	Half cycle sine wave, positive side, 10 ms, 1 shot	
I ² t Limiting Value	I^2t	1.1	A^2s	$1 \text{ ms} \le t \le 10 \text{ ms}$	
Junction Temperature	T_{J}	-40 to 150	°C		
Storage Temperature	T_{STG}	-40 to 150	°C		

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Command Voltage Duen	V_{F}	$T_J = 25 ^{\circ}\text{C}, I_F = 0.7 \text{A}$	_	_	2.0	V
Forward Voltage Drop		$T_J = 100 ^{\circ}\text{C}, I_F = 0.7 \text{A}$	_	1.0	_	V
Reverse Leakage Current	I_R	$V_R = V_{RM}$	_	_	50	μΑ
Reverse Leakage Current Under High Temperature	$H \cdot I_R$	$V_R = V_{RM}$, $T_J = 100 ^{\circ}C$	_		300	μΑ
	t _{rr1}	$I_F = I_{RP} = 100 \text{ mA}$ 90% recovery point, $T_J = 25 ^{\circ}\text{C}$	_	_	100	ns
Reverse Recovery Time	t _{rr2}	$I_F = 100 \text{ mA},$ $I_{RP} = 200 \text{ mA},$ $75\% \text{ recovery point},$ $T_J = 25 \text{ °C}$	_		50	ns
Thermal Resistance (1)	R _{th(J-L)}	See Figure 1	_	_	20	°C/W

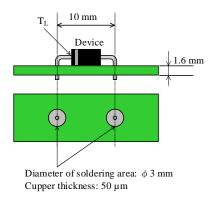
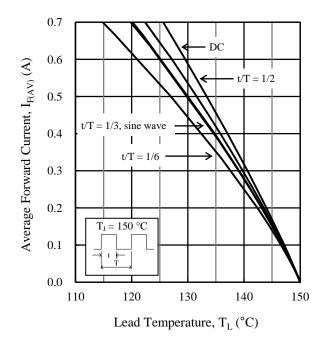


Figure 1 Lead Temperature Measurement Conditions

 $^{^{(1)}\,}R_{\text{th (J-L)}}$ is thermal resistance between junction and lead.

Rating and Characteristic Curves



 $Figure~2.~~I_{F(AV)}~vs.~T_L~Typical~Characteristics^{(2)}$ $(V_R = 0 V)$

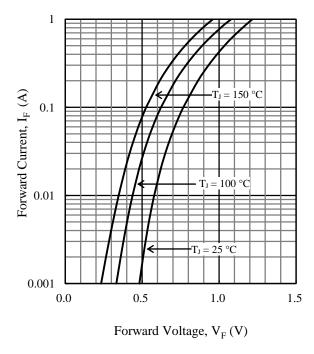


Figure 4. V_F vs. I_F Typical Characteristics

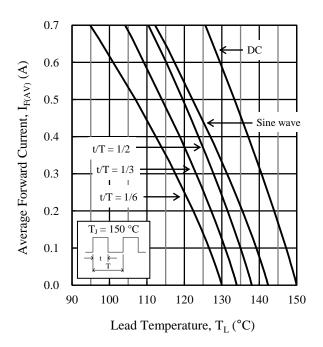


Figure 3. $I_{F(AV)}$ vs. T_L Typical Characteristics⁽²⁾ $(V_R = 400 \text{ V})$

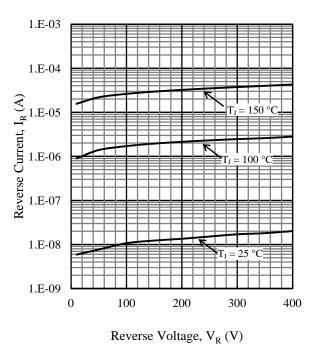
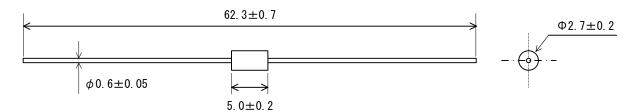


Figure 5. V_R vs. I_R Typical Characteristics

⁽²⁾ See Figure 1 for the lead temperature measurement conditions.

Physical Dimensions

• Axial $(\varphi 2.7 \times 5.0 L / \varphi 0.6)$



NOTES:

- Dimensions in millimeters
- Bare leads: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time, within the following limits: Flow: 260 ± 5 °C / 10 ± 1 s, 2 times Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

Marking Diagram

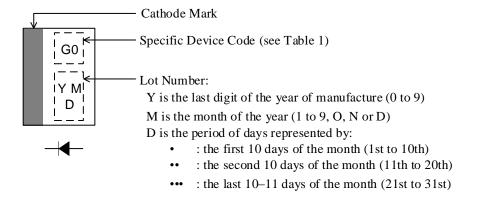


Table 1. Specific Device Code

Specific Device Code	Part Number
G0	EG01

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